



Photocopier Product Data Sheet MOC3020 THRU MOC3023 SERIES

Spec No. :DS-70-99-0019
Effective Date: 06/16/2021
Revision: K

LITE-ON DCC

RELEASE

BNS-OD-FC001/A4

Photocoupler MOC302X series

1. DESCRIPTION

1.1 Features

- Isolation voltage between input and output V_{iso} : 5,000V_{rms}
- 6pin DIP photocoupler, triac driver output
- High repetitive peak off-state voltage V_{DRM} : Min. 400V
- High critical rate of rise of off-state voltage(dV/dt : MIN. 1000V / μ s)
- Dual-in-line package : MOC3020, MOC3021, MOC3022, MOC3023
- Wide lead spacing package : MOC3020M, MOC3021M, MOC3022M, MOC3023M
- Surface mounting package : MOC3020S, MOC3021S, MOC3022S, MOC3023S
- Tape and reel packaging : MOC3020S-TA, MOC3021S-TA, MOC3022S-TA, MOC3023S-TA
MOC3020S-TA1, MOC3021S-TA1, MOC3022S-TA1, MOC3023S-TA1
- Safety approval
UL 1577
VDE DIN EN60747-5-5 (VDE 0884-5)
CSA CA5A
CQC GB4943.1-2011/ GB8898-2011 (meet Altitude up to 5000m)
Nordic Safety (DEMKO)
- RoHS Compliance
All materials be used in device are followed EU RoHS directive (No.2002/95/EC).
- MSL class1
- Halogen free option

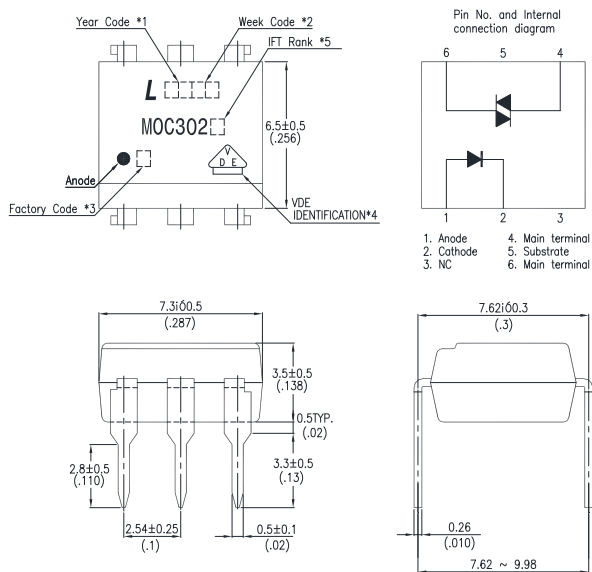
1.2 Applications

- AC Motor Drives
- AC Motor Starters
- E.M. Contactors
- Lighting Controls
- Solenoid/Valve Controls
- Solid State Relays
- Static Power Switches
- Temperature Controls

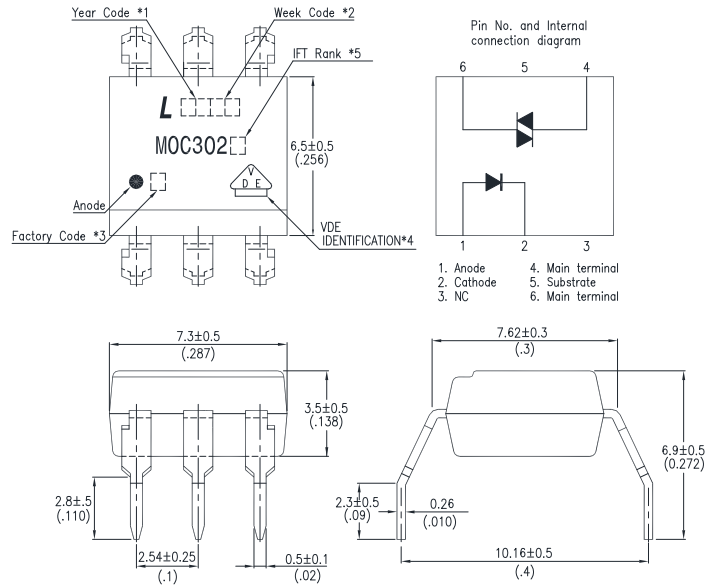
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2. PACKAGE DIMENSIONS

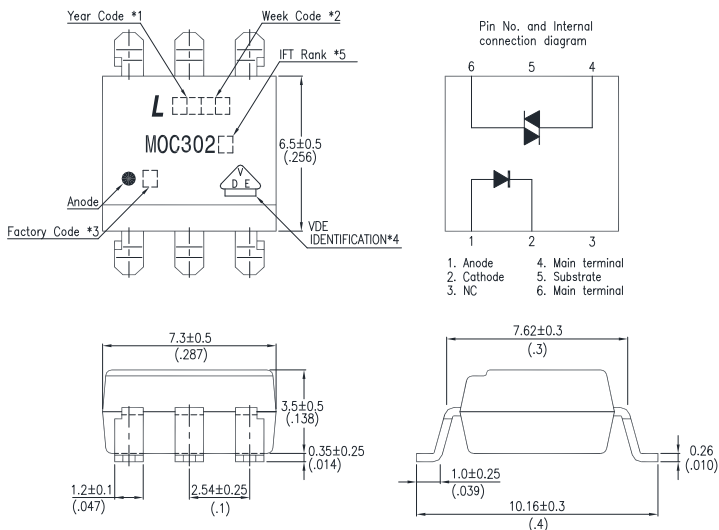
2.1 MOC302X



2.2 MOC302XM



2.3 MOC302XS



Notes :

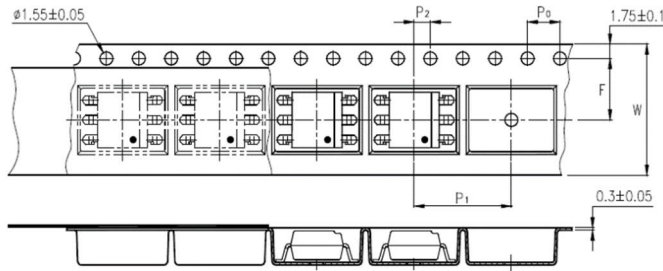
1. 2-digit year code, example : 2016 = 16
2. 2-digit work week ranging from '01' to '53'
3. Factory identification mark shall be marked (W: China-CZ, Y: Thailand)
4. VDE option
5. IFT rank

* Dimensions are in Millimeters and (Inches).

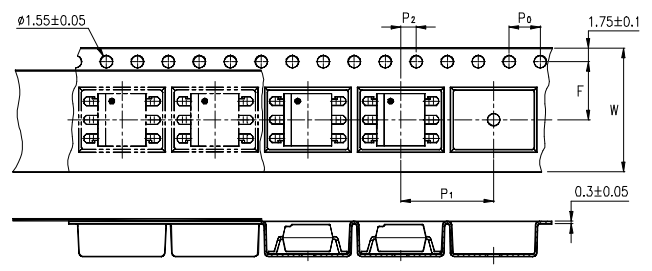
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3. TAPING DIMENSIONS

3.1 MOC302XS-TA



3.2 MOC302XS-TA1



| Description | Symbol | Dimension in mm (inch) |
|--|----------------|------------------------|
| Tape wide | W | 16±0.3 (0.63) |
| Pitch of sprocket holes | P ₀ | 4±0.1 (0.15) |
| Distance of compartment | F | 7.5±0.1 (0.295) |
| | P ₂ | 2±0.1 (0.079) |
| Distance of compartment to compartment | P ₁ | 12±0.1 (0.472) |

3.3 Quantities Per Reel

| Package Type | MOC302XS series |
|------------------|-----------------|
| Quantities (pcs) | 1000 |

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4. RATING AND CHARACTERISTICS

4.1 Absolute Maximum Ratings at Ta=25°C

| | Parameter | Symbol | Rating | Unit |
|--------|---|-----------|------------|-----------|
| Input | Forward Current | I_F | 50 | mA |
| | Reverse Voltage | V_R | 6 | V |
| | Junction Temperature | T_J | 125 | °C |
| | Power Dissipation | P | 70 | mW |
| Output | Off-State Output Terminal Voltage | V_{DRM} | 400 | V |
| | Peak Repetitive Surge Current (PW=1ms, 120pps) | I_{TSM} | 1 | A |
| | Junction Temperature | T_J | 125 | °C |
| | Collector Power Dissipation | P_C | 300 | mW |
| | Total Power Dissipation | P_{tot} | 330 | mW |
| 1. | Isolation Voltage | V_{iso} | 5000 | V_{rms} |
| | Operating Temperature | T_{opr} | -40 ~ +110 | °C |
| | Storage Temperature | T_{stg} | -55 ~ +150 | °C |
| 2. | Soldering Temperature | T_{sol} | 260 | °C |

1. AC For 1 Minute, R.H. = 40 ~ 60%

Isolation voltage shall be measured using the following method.

- (1) Short between anode and cathode on the primary side and between collector and emitter on the secondary side.
- (2) The isolation voltage tester with zero-cross circuit shall be used.
- (3) The waveform of applied voltage shall be a sine wave.

2. For 10 Seconds

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4.2 Recommended Operating Conditions (Note)

| Characteristics | Symbol | Min. | Typ. | Max. | Unit |
|-----------------------|-----------|------|------|------|------|
| Supply Voltage | V_{AC} | - | - | 120 | Vac |
| Forward Current | MOC3021 | 22.5 | 25 | 30 | mA |
| | MOC3022 | 15 | 20 | 30 | mA |
| | MOC3023 | 7.5 | 10 | 30 | mA |
| Operating Temperature | T_{opr} | -25 | - | 85 | °C |

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device.

Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

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4.3 Electrical Optical Characteristics at Ta=25°C

| Parameter | | Symbol | Min. | Typ. | Max. | Unit | Test Condition |
|-----------|---|-----------|------|------|------|------------------|-----------------------------|
| Input | Forward Voltage | V_F | — | 1.15 | 1.4 | V | $I_F=20\text{mA}$ |
| | Reverse Current | I_R | — | 0.05 | 10 | μA | $V_R=6\text{V}$ |
| Output | 1 Peak Blocking Current, Either Direction | I_{DRM} | — | 10 | 100 | nA | $V_{DRM} = 400\text{V}$ |
| | Peak On-State Voltage, Either Direction | V_{TM} | — | — | 3.0 | V | $I_{TM}=100\text{ mA Peak}$ |
| | 2 Critical rate of Rise of Off-State Voltage | dv/dt | 1000 | — | — | V/ μs | $V_{in}=240\text{Vrms}$ |
| Couple | Led Trigger Current, Current Required to Latch Output, Either Direction | MOC3021 | — | — | 15 | mA | Main Terminal Voltage = 3V |
| | | MOC3022 | — | — | 10 | | |
| | | MOC3023 | — | — | 5 | | |
| | Holding Current, Either Direction | I_H | — | 200 | — | μA | |

*1. Test voltage must be applied within dv/dt rating.

*2. This is static dv/dt. Commutating dv/dt is a function of the load-driving thyristor(s) only.

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5. CHARACTERISTICS CURVES (TYPICAL PERFORMANCE)

Fig.1 Forward Current vs. Ambient Temperature

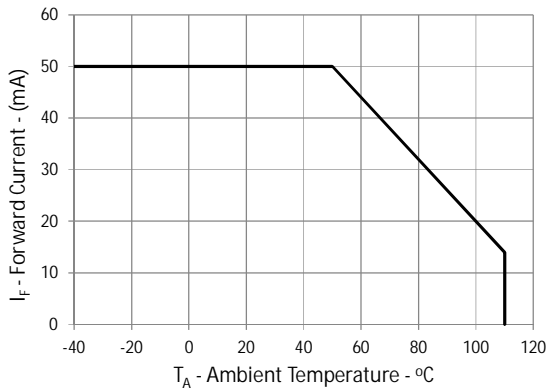


Fig.2 On-state Current vs. Ambient Temperature

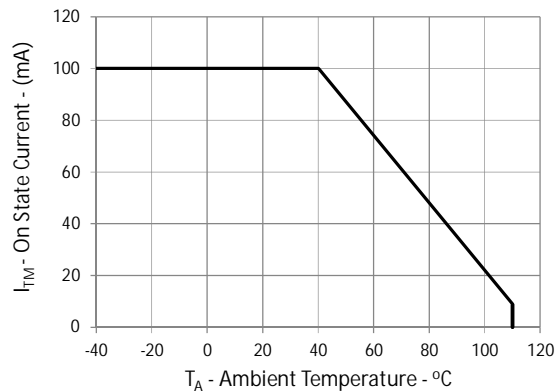


Fig.3 Normalized Trigger Current vs Ambient Temperature

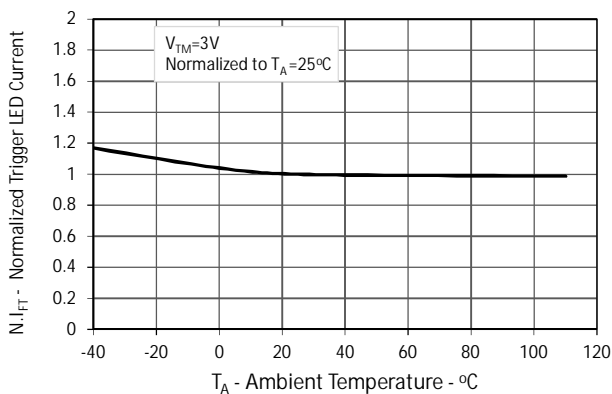


Fig.4 Forward Current vs. Forward Voltage

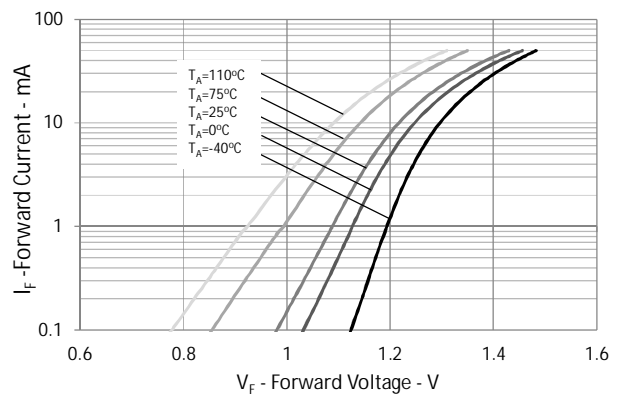


Fig.5 Normalized On-state Voltage vs Ambient Temperature

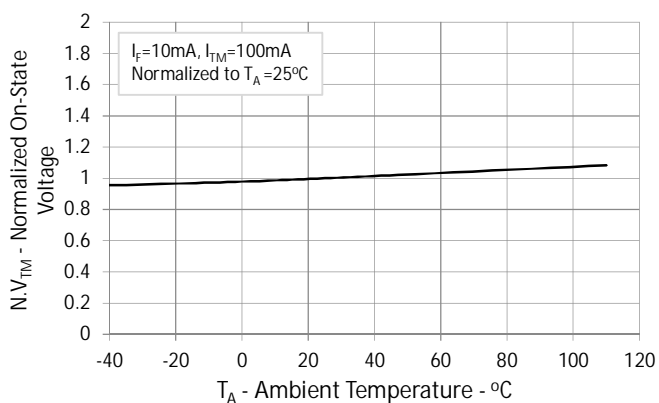
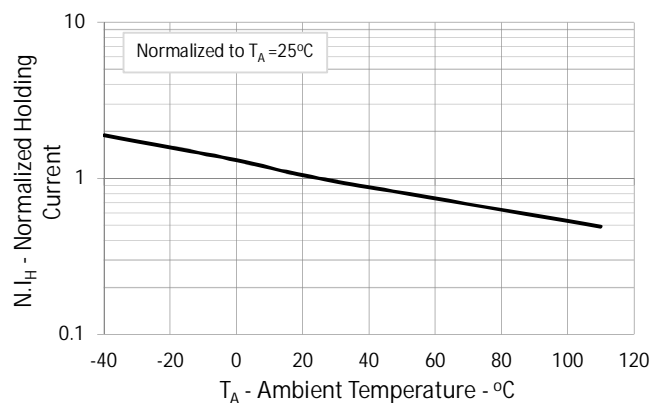


Fig.6 Normalized Holding Current vs Ambient Temperature



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Fig.7 Off-state Current vs Ambient Temperature

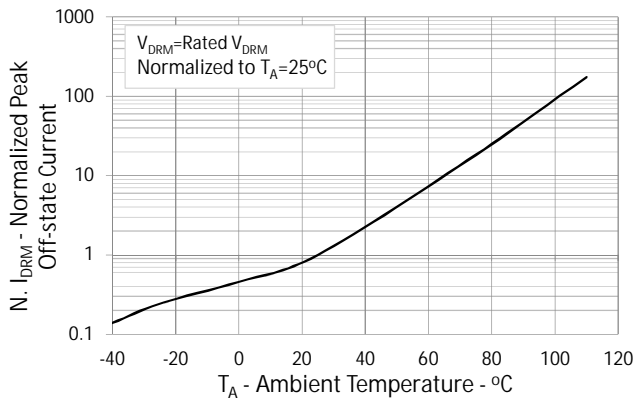
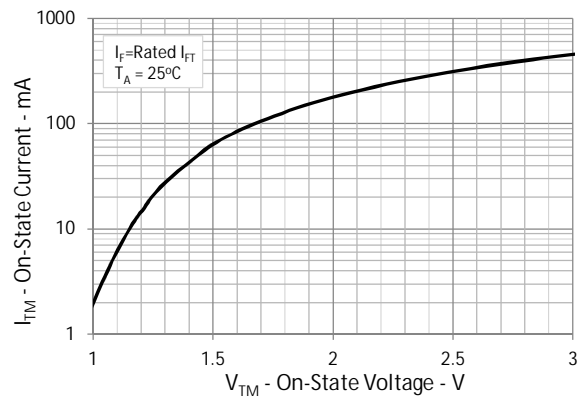
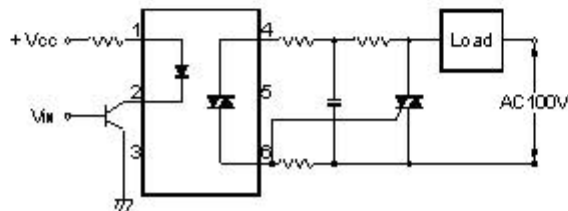


Fig.8 On-state Current vs On-state Voltage



Basic Operation Circuit
Medium/High Power Triac Drive Circuit



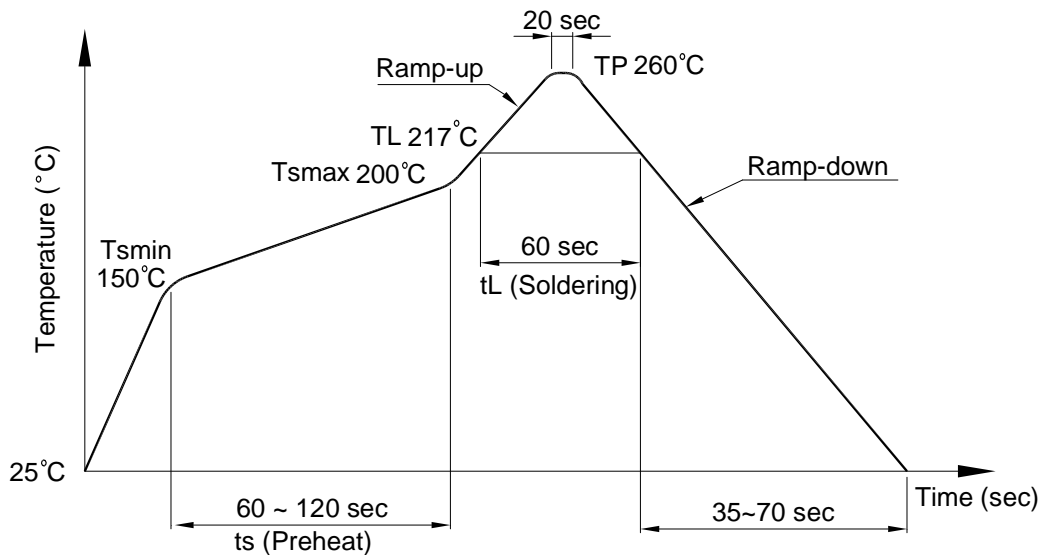
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6. TEMPERATURE PROFILE OF SOLDERING

6.1 IR Reflow soldering (JEDEC-STD-020E compliant)

One time soldering reflow is recommended within the condition of temperature and time profile shown below. Do not solder more than three times.

| Profile item | Conditions |
|----------------------------------|----------------|
| Preheat | |
| - Temperature Min (T_{Smin}) | 150°C |
| - Temperature Max (T_{Smax}) | 200°C |
| - Time (min to max) (ts) | 90±30 sec |
| Soldering zone | |
| - Temperature (T_L) | 217°C |
| - Time (t_L) | 60 sec |
| Peak Temperature (T_P) | 260°C |
| Ramp-up rate | 3°C / sec max. |
| Ramp-down rate | 3~6°C / sec |



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6.2 Wave soldering (JEDEC22A111 compliant)

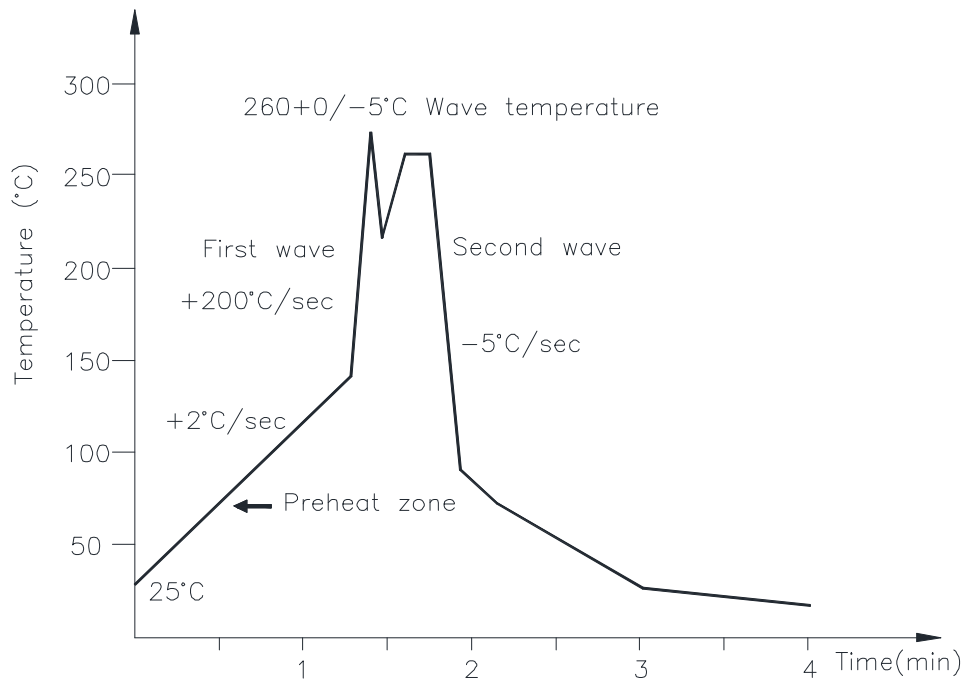
One time soldering is recommended within the condition of temperature.

Temperature: $260 \pm 0 / -5^{\circ}\text{C}$

Time: 10 sec.

Preheat temperature: 25 to 140°C

Preheat time: 30 to 80 sec.



6.3 Hand soldering by soldering iron

Allow single lead soldering in every single process. One time soldering is recommended.

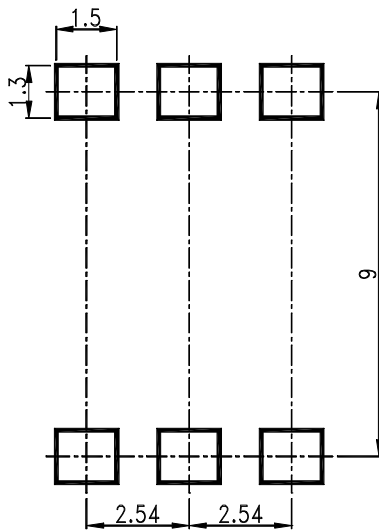
Temperature: $380 \pm 0 / -5^{\circ}\text{C}$

Time: 3 sec max.

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7. RECOMMENDED FOOT PRINT PATTERNS (MOUNT PAD)

Unit: mm



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8. NAMING RULE

MOC302(X)(1)-(2)-G

DEVICE PART NUMBER (MOC302X)

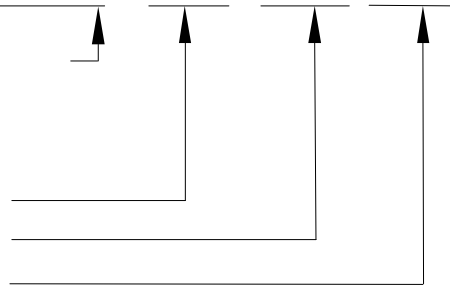
Please refer to Electrical Optical Characteristics Table on Page 6

(1) FORM TYPE (S, M or none)

(2) TAPING TYPE (TA, TA1)

(3) Halogen free

Example : MOC3021S-TA1-G



MOC302(X)(1)(2)-V-G

DEVICE PART NUMBER (MOC302X)

Please refer to Electrical Optical Characteristics Table on Page 6

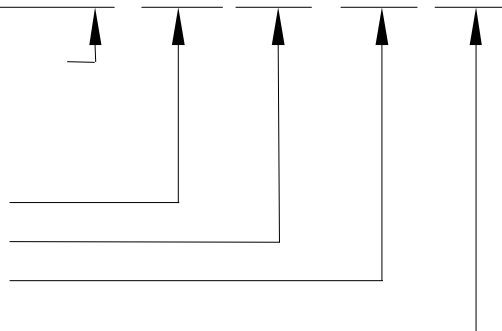
(1) FORM TYPE (S, M or none)

(2) TAPING TYPE (TA, TA1)

(3) VDE option

(4) Halogen free

Example : MOC3021STA1-V-G



9. NOTES

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- The products shown in this publication are designed for the general use in electronic applications such as office automation equipment, communications devices, audio/visual equipment, electrical application and instrumentation.
- For equipment/devices where high reliability or safety is required, such as space applications, nuclear power control equipment, medical equipment, etc, please contact our sales representatives.
- When requiring a device for any "specific" application, please contact our sales in advice.
- If there are any questions about the contents of this publication, please contact us at your convenience.
- The contents described herein are subject to change without prior notice.
- Immerse unit's body in solder paste is not recommended.